

FDV303N Digital FET, N-Channel

General Description

These N-Channel enhancement mode field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is tailored to minimize on-state resistance at low gate drive conditions. This device is designed especially for application in battery circuits using either one lithium or three cadmium or NMH cells. It can be used as an inverter or for high-efficiency miniature discrete DC/DC conversion in compact portable electronic devices like cellular phones and pagers. This device has excellent on-state resistance even at gate drive voltages as low as 2.5 volts.

Features

- Very low level gate drive requirements allowing direct operation in 3V circuits. V_{GS(th)} < 1V.

July 2014

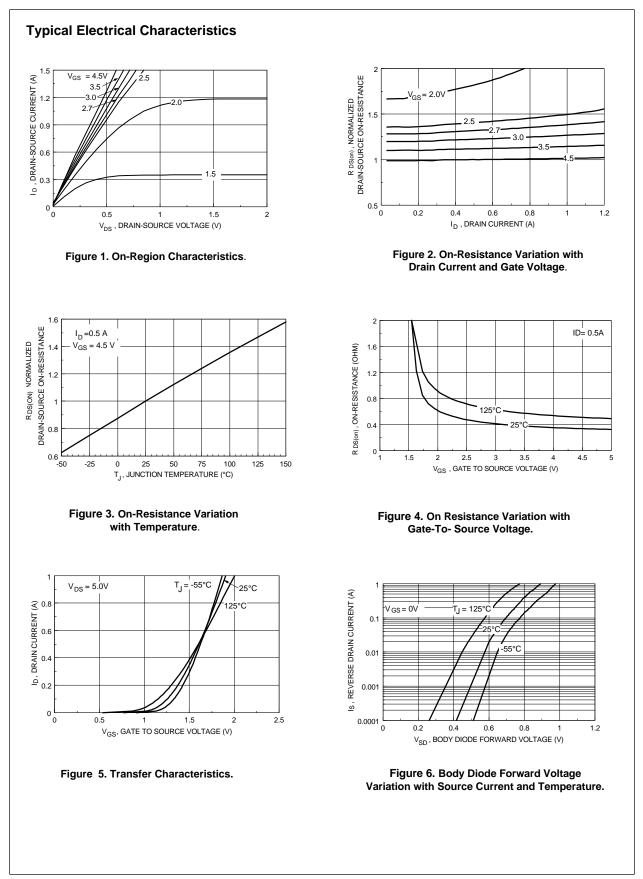
- Gate-Source Zener for ESD ruggedness.>6kV Human Body Model
- Compact industry standard SOT-23 surface mount package.
- Alternative to TN0200T and TN0201T.

I					
SO	T-23 SuperSOT [™] -6	SuperSOT [™] -8	SO-8	SOT-223	SOIC-16
Mark	k:303			D	
	D	s			
Abool	SOT-23			G	S
			oted	G FDV303N	S Units
ymbol	SOT-23	= 25°C unless other wise no	oted		
ymbol _{DSS}	SOT-23 ute Maximum Ratings T _A Parameter	= 25°C unless other wise no	ted	FDV303N	Units
ymbol DSS GSS	SOT-23 ute Maximum Ratings T_A Parameter Drain-Source Voltage, Power Su Gate-Source Voltage, V _{IN}	= 25°C unless other wise no	oted	FDV303N 25	Units V
ymbol DSS GSS	SOT-23 ute Maximum Ratings T_A Parameter Drain-Source Voltage, Power Su Gate-Source Voltage, V _{IN}	= 25°C unless other wise no upply Voltage	ted	FDV303N 25 8	Units V V V
ymbol DSS GSS	SOT-23 ute Maximum Ratings T_A Parameter Drain-Source Voltage, Power Su Gate-Source Voltage, V_IN Drain/Output Current	= 25°C unless other wise no upply Voltage	oted	FDV303N 25 8 0.68	Units V V V
ymbol DSS GSS	SOT-23 ute Maximum Ratings T_A Parameter Drain-Source Voltage, Power Su Gate-Source Voltage, V _{IN} Drain/Output Current - Con - Puls - Puls	= 25°C unless other wise no upply Voltage tinuous sed		FDV303N 25 8 0.68 2	Units V V A
Coss Coss Coss Coss Coss Coss Coss Coss	SOT-23 ute Maximum Ratings T_A Parameter Drain-Source Voltage, Power Su Gate-Source Voltage, V_IN Drain/Output Current Drain/Output Current - Con - Pulse Maximum Power Dissipation	= 25°C unless other wise no upply Voltage ttinuous sed uture Range MIL-STD-883D	ted	FDV303N 25 8 0.68 2 0.35	Units V V A W
Symbol / _{DSS} / _{GSS} / GSD / _D / _D / _D / _D / _D / _D / _{DSS}	SOT-23 Ute Maximum Ratings T _A Parameter Drain-Source Voltage, Power Su Gate-Source Voltage, V _{IN} Drain/Output Current - Con - Puls Maximum Power Dissipation Operating and Storage Tempera Electrostatic Discharge Rating I	= 25°C unless other wise no upply Voltage ttinuous sed uture Range MIL-STD-883D		FDV303N 25 8 0.68 2 0.35 -55 to 150	Units V V A W °C

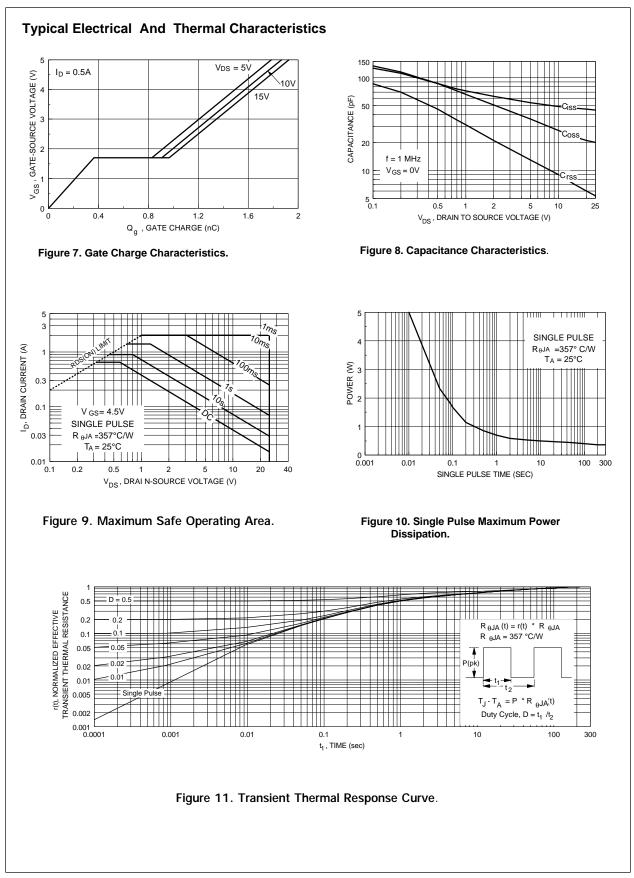
© 1997 Fairchild Semiconductor Corporation

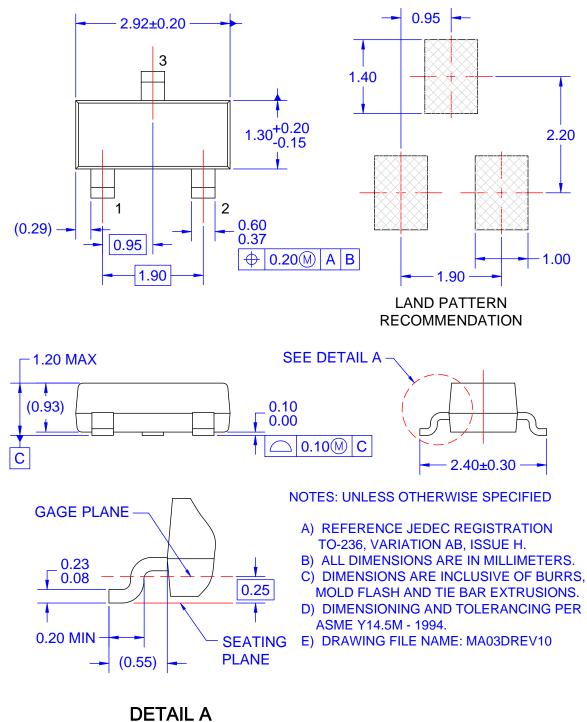
Symbol	Parameter	Conditions	Min	Тур	Max	Units
OFF CHAR	ACTERISTICS	·				
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$	25			V
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_{\rm D}$ = 250 µA, Referenced to 25 °C		26		mV / °C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$			1	μA
		$T_{J} = 55^{\circ}C$			10	μA
I _{GSS}	Gate - Body Leakage Current	$V_{gs} = 8 V, V_{Ds} = 0 V$			100	nA
	CTERISTICS (Note)					1
$\Delta V_{GS(th)} / \Delta T_{J}$	Gate Threshold Voltage Temp. Coefficient	$I_{\rm D}$ = 250 µA, Referenced to 25 °C		-2.6		mV / °C
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, \ I_{D} = 250 \ \mu A$	0.65	0.8	1	V
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 0.5 \text{ A}$		0.33	0.45	Ω
		T _{.1} =125°C		0.52	0.8	
		$V_{GS} = 2.7 \text{ V}, \ I_{D} = 0.2 \text{ A}$		0.44	0.6	
I _{D(ON)}	On-State Drain Current	$V_{GS} = 2.7 \text{ V}, V_{DS} = 5 \text{ V}$	0.5			А
9 _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 0.5 A$		1.45		S
DYNAMIC C	HARACTERISTICS		•		•	
C _{iss}	Input Capacitance	$V_{DS} = 10 V, V_{GS} = 0 V,$		50		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		28		pF
C _{rss}	Reverse Transfer Capacitance			9		pF
SWITCHING	CHARACTERISTICS (Note)					
t _{D(on)}	Turn - On Delay Time	$V_{DD} = 6 V, I_{D} = 0.5 A,$		3	6	ns
ţ,	Turn - On Rise Time	$V_{GS} = 4.5 \text{ V}, \text{ R}_{GEN} = 50 \Omega$		8.5	18	ns
t _{D(off)}	Turn - Off Delay Time			17	30	ns
t,	Turn - Off Fall Time			13	25	ns
Q _g	Total Gate Charge	$V_{DS} = 5 V, I_{D} = 0.5 A, V_{GS} = 4.5 V$		1.64	2.3	nC
Q _{gs}	Gate-Source Charge			0.38		nC
Q _{gd}	Gate-Drain Charge			0.45		nC
DRAIN-SOU	IRCE DIODE CHARACTERISTICS AND	MAXIMUM RATINGS				
I _s	Maximum Continuous Drain-Source Diode F	orward Current			0.3	А
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 0.5 A$ (Note)		0.83	1.2	V

Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%.



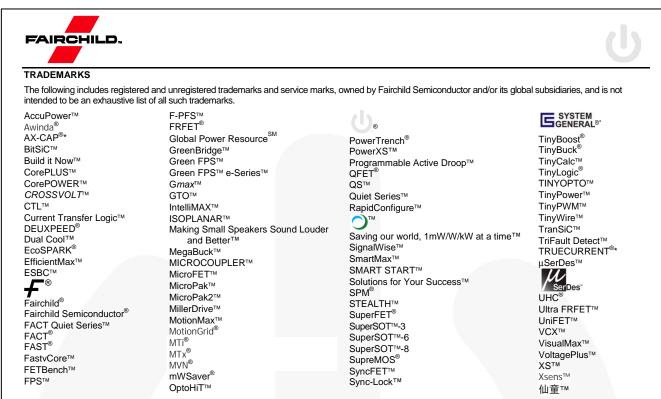
FDV303N Rev.D2





SCALE: 2X

E: 2X



* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. TO OBTAIN THE LATEST, MOST UP-TO-DATE DATASHEET AND PRODUCT INFORMATION, VISIT OUR WEBSITE AT <u>HTTP://WWW.FAIRCHILDSEMI.COM</u>, FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Datasheet Identification	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary First Production		Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		